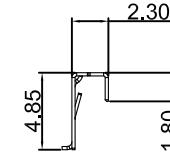
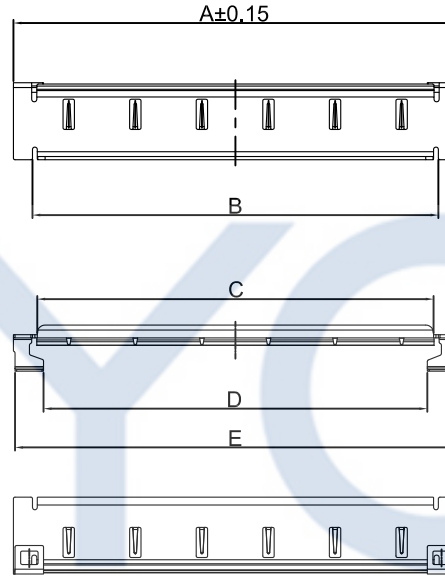
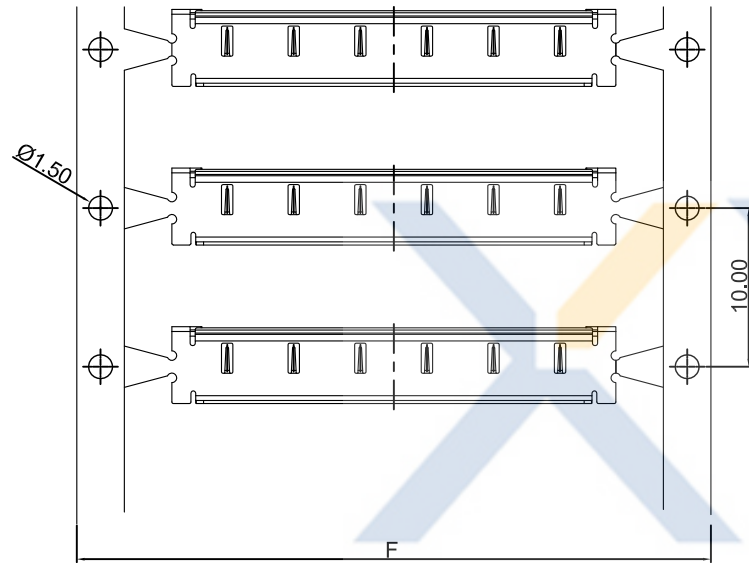


DRAWING FOR CUSTOMER



KB904-XX S S 1 A

Pin No. Version
Solder Type Mold No. Shell

1.MATERIAL: STAINLESS STEEL
2.PLATING:MATTE-TIN PLATED 50u"(MIN);
OVER NI PLATED 40u"(MIN)

Pin No	Dimension	A	B	C	D	E	F
51 pin		28.00	25.60	25.00	24.20	27.80	40.00
41 pin		23.00	20.60	20.00	19.20	22.80	35.00

DATE 日期	VER 版本	CHANGE HISTORY 變更歷史	CHANGED NAME 修改後料號	DRAWING 變更者	TOLERANCE 公差	DRAWING 設計者	Devin
2019-10-09	A		KB904-XXSS1A	Devin	.X=±0.30 .XX=±0.20 .XXX=±0.10	CHECKED 審查	Thomas
						APPROVED 核准	William

KB904-XXSS1A	
PART NO. 料號	
DWG NO. 圖號	PE190924A

XYCO 东莞市轩业电子科技有限公司
TEL: 0769-8297 9981/2/3 <http://www.XYCO.com.cn>

UNIT 單位	mm	PRODUCT NAME 產品名稱	FI-RE XXP Wire To Board Solder Type Upper Shell
------------	----	----------------------	--